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# Headset/Speaker EMI Filter with ESD Protection

CM1416

### **Features**

- Functionally and pin compatible with the CSPEMI201A and CM1411
- OptiGuard<sup>™</sup> coated for improved reliability at assembly
- Two channels of EMI filtering for  $8\Omega$  speakers
- Pi-style EMI filters in a capacitor-resistorcapacitor (C-R-C) network
- Greater than 30dB attenuation at 1GHz
- ±30kV ESD protection on each channel per IEC 61000-4-2 Level 4, contact discharge
- Extremely low lead inductance for optimum filter and ESD performance
- 5-bump, 0.96mm X 1.33mm footprint Chip Scale Package (CSP)
- RoHS-compliant, lead-free finishing

# **Applications**

- Headset Speaker port in mobile handsets
- I/O port protection for mobile handsets, notebook computers, PDAs etc.
- EMI filtering for data ports in cell phones, PDAs or notebook computers.

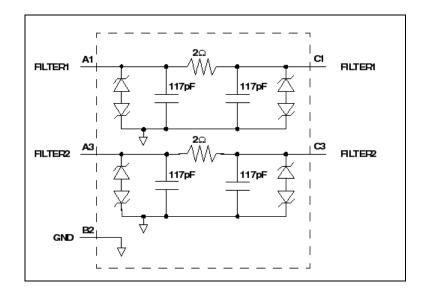
### **Product Description**

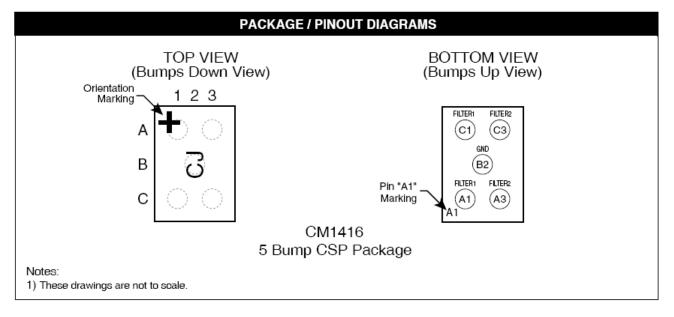
The CM1416 is an EMI filter array with ESD protection, which integrates two Pi-filters (C-R-C). The CM1416 has component values of 117pF-2Ω-117pF. The parts include avalanche-type ESD diodes on every pin, which provide a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD diodes safely dissipate ESD strikes of ±30kV, exceeding the maximum requirement of the IEC 61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, these devices protect for contact discharges at greater than ±30kV.

This device is well suited for portable electronics (e.g. mobile handsets, PDAs, notebook computers) because of its small package and easy-to-use pin assignments. In particular, the CM1416 is ideal for filtering unwanted EMI-induced noise and providing ESD protection for headset speaker port applications in wireless handsets with  $8\Omega$  speakers.

The CM1416 incorporates *OptiGuard*<sup>™</sup> coating which results in improved reliability at assembly. The CM1416 is available in a space saving, low profile Chip Scale Package with RoHS-compliant, lead-free finishing.

# **Block Diagram**





	PIN DESCRIPTIONS			
PIN	NAME	DESCRIPTION		
A1	FILTER1	EMI Filter 1		
А3	FILTER2	EMI Filter 2		
B2	GND	Device Ground		
C1	FILTER1	EMI Filter 1		
СЗ	FILTER2	EMI Filter 2		

# **Ordering Information**

PART NUMBERING INFORMATION					
		Lead-free Finish			
Pins	Package	Ordering Part Number <sup>1</sup>	Part Marking		
5	CSP	CM1416-03CP	CJ		

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

# **Specifications**

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	RATING	UNITS		
Storage Temperature Range	-65 to +150	°C		
DC Power per Resistor (note 5)	100	mW		
DC Package Power Rating (note 5)	500	mW		

STANDARD OPERATING CONDITIONS					
PARAMETER	RATING	UNITS			
Operating Temperature Range	-40 to +85	°C			

#### ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE 1) **SYMBOL PARAMETER CONDITIONS TYP** MAX UNITS MIN R R1 Resistance 2 Ω $\mathbf{C}_{\text{\tiny TOT}}$ Total Channel Capacitance At 2.5VDC, 1MHz, 187 234 281 рF 30mVAC рF C, C1 Capacitance At 2.5VDC, 1MHz, 93 117 140 30mVAC ٧ $V_{\text{DIODE}}$ Diode Standoff Voltage $I_{\text{\tiny DIODE}}=10\mu A$ 6.0 $V_{1N} = 3.3V$ 0.1 2 Diode Leakage Current μΑ LEAK (reverse bias voltage) Signal Clamp Voltage $V_{\scriptscriptstyle{\text{SIG}}}$ Positive Clamp $I_{LOAD} = 10mA$ 6.4 7.6 9.8 ٧ **Negative Clamp** $I_{LOAD} = -10 \text{mA}$ -9.8 -7.6 -6.4 In-system ESD Withstand Voltage $V_{\scriptscriptstyle{\text{ESD}}}$ Note 2 a) Human Body Model, MIL-STD-883, kV ±30 Method 3015 b) Contact Discharge per IEC 61000-4-2 kV ±30 Level 4 $\boldsymbol{R}_{\scriptscriptstyle DYN}$ Dynamic Resistance Positive 0.95 Ω Negative 0.90 Ω $\mathbf{f}_{\mathrm{c}}$ **Cut-off frequency** $R = 2\Omega, C = 117pF$ 21 MHz $Z_{\text{SOURCE}} = 50\Omega, Z_{\text{LOAD}} = 50\Omega$

Note 1:  $T_A=25^{\circ}C$  unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

# **Performance Information**

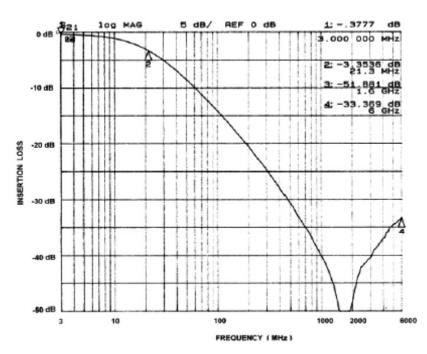


Figure 1. Typical EMI Filter Performance (0VDC, 50 Ohm Environment)

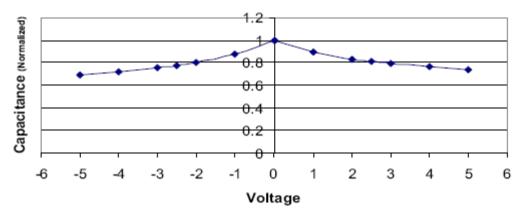


Figure 2. Typical Diode Capacitance VS. Input Voltage (normalized to 2.5VDC)

# **Application Information**

PARAMETER	VALUE
Pad Size on PCB	0.240mm
Pad Shape	Round
Pad Definition	Non-Solder Mask defined pads
Solder Mask Opening	0.290mm Round
Solder Stencil Thickness	0.125mm - 0.150mm
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.300mm Round
Solder Flux Ratio	50/50 by volume
Solder Paste Type	No Clean
Pad Protective Finish	OSP (Entek Cu Plus 106A)
Tolerance — Edge To Corner Ball	<u>+</u> 50μm
Solder Ball Side Coplanarity	<u>+</u> 20μm
Maximum Dwell Time Above Liquidous	60 seconds
Maximum Soldering Temperature for Lead-free Devices using a Lead-free Solder Paste	260°C

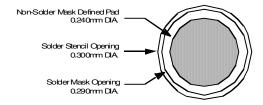


Figure 5. Recommended Non-Solder Mask Defined Pad Illustration

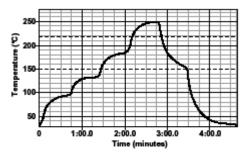


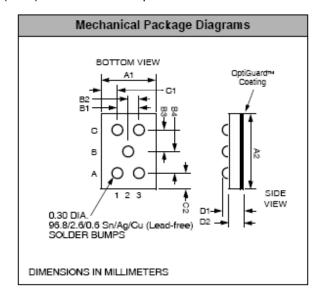
Figure 6. Lead-free (SnAgCu) Solder Ball Reflow Profile

# **Mechanical Details**

### **CSP Mechanical Specifications**

The CM1416 is supplied in a custom Chip Scale Package (CSP). Dimensions are presented below.

PACKAGE DIMENSIONS							
Pack	age	Custom CSP					
Bun	nps	5					
Dim	Millimeters		rs	Inches			
J	Min	Nom	Max	Min	Nom	Max	
<b>A</b> 1	0.955	1.000	1.045	0.0376	0.0394	0.0411	
A2	1.325	1.370	1.415	0.0522	0.0557		
B1	0.495	0.500	0.505	0.0195	0.0197	0.0199	
B2	0.245	0.250	0.255	0.0096	0.0098	0.0100	
В3	0.430	0.435	0.440	0.0169	0.0171	0.0173	
B4	0.430	0.435	0.440	0.0169	0.0171	0.0173	
C1	0.200	0.250	0.300	0.0079	0.0098	0.0118	
C2	0.200	0.250	0.300	0.0079 0.0098		0.0118	
D1	0.575	0.644	0.714	0.0226	0.0254	0.0281	
D2	0.368	0.419	0.470	0.0145	0.0165	0.0185	
# per tape and reel		3500 pieces					
	Controlling dimension: millimeters						



Package Dimensions for CM1416 Chip Scale Package

## **CSP Tape and Reel Specifications**

PART NUMBER	CHIP SIZE (mm)	POCKET SIZE (mm) B <sub>o</sub> X A <sub>o</sub> X K <sub>o</sub>	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P <sub>o</sub>	<b>P</b> ,
CM1416	1.33 x 0.96 x 0.644	1.42 x 1.07 x 0.74	8mm	178mm (7")	3500	4mm	4mm

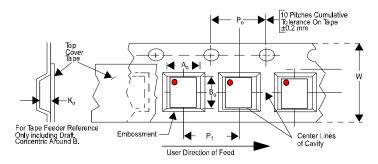


Figure 5. Tape and Reel Mechanical Data

# CM1416

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